Panasonic

Schottky Barrier Diode

DB2G60800L1

For rectification

#### Features

• Low forward voltage VF

DB2G60800L1

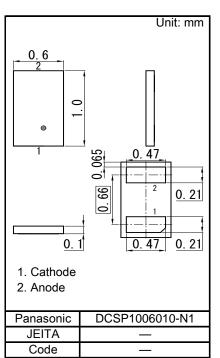
- Forward current (Average) IF(AV) ≦ 1.0 A rectification is possible
- RoHS compliant
- (EU RoHS / MSL:Level 1 compliant)
- Marking Symbol: D7

#### Packaging

Embossed type (Thermo-compression sealing): 1 000 pcs / reel (standard)

#### Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Reverse Voltage <sup>*1</sup>	VR	-	60	V
Maximum Peak Reverse Voltage *1	VRM	-	60	V
Average Forward Current *2,3	IF(AV)	-	1.0	Α
Average Forward Current *2,4	IF(AV)	-	1.0	Α
Non-repetitive Peak Surge Forward Current *1,5	IFSM	-	10	Α
Operating Junction Temperature *6	Tj	-	150	°C
Ambient Temperature	Та	-40	+150	°C
Storage Temperature	Tstg	-55	+150	°C



Note) \*1: Ta = Tj = 25°C

\*2: Square wave :  $\sigma$  = 0.5

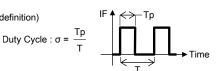
\*3: Ta  $\leq$  85°C, when device mounted on a FR4 PCB (25.4mm×25.4mm, 1mm thick), (620.0mm<sup>2</sup> area, 36µm thick).

\*4: Solder Point Temperature : Tsp ≦ 135°C

\*5: Square wave : Tp = 5 ms

\*6: Power derating is necessary so that  $Tj < 150^{\circ}C$ .

(Waveform definition)



#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward Voltage	VF	IF = 1.0 A	-	0.6	0.68	V
Reverse Current	IR	VR = 60 V	-	3	40	μA
Terminal Capacitance	Ct	VR = 10 V, f = 1 MHz	-	20	-	pF
Reverse Recovery Time <sup>*1</sup>	trr	IF = IR = 100 mA, Irr = 10 mA	-	6.6	-	ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
2. This product is sensitive to electric shock (static electricity, etc.).

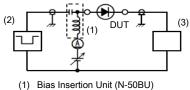
Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment. 3. \*1: Measurement circuit, input pulse, output pulse for Reverse recovery time

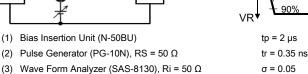
(Input pulse)

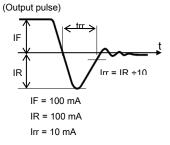
tp

10%

(Measurement circuit)





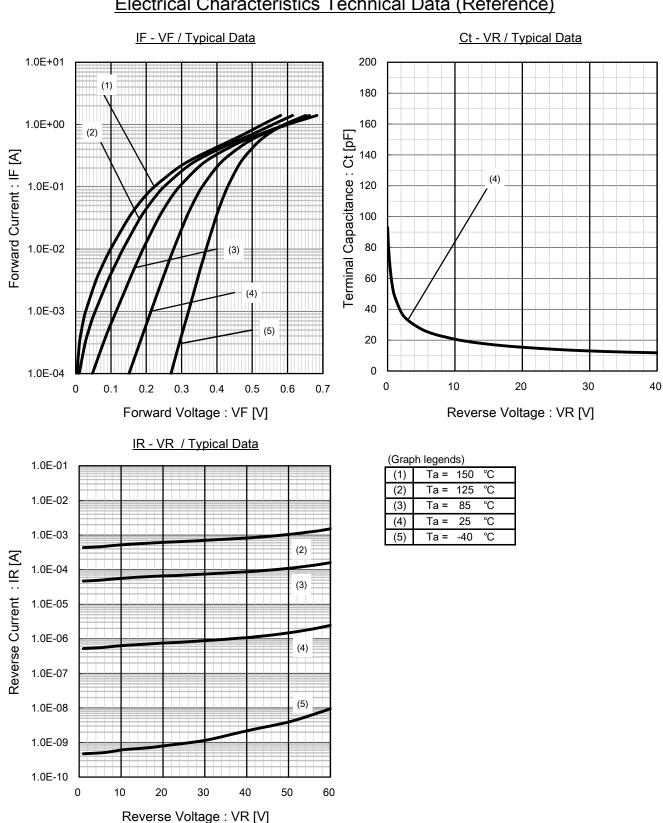


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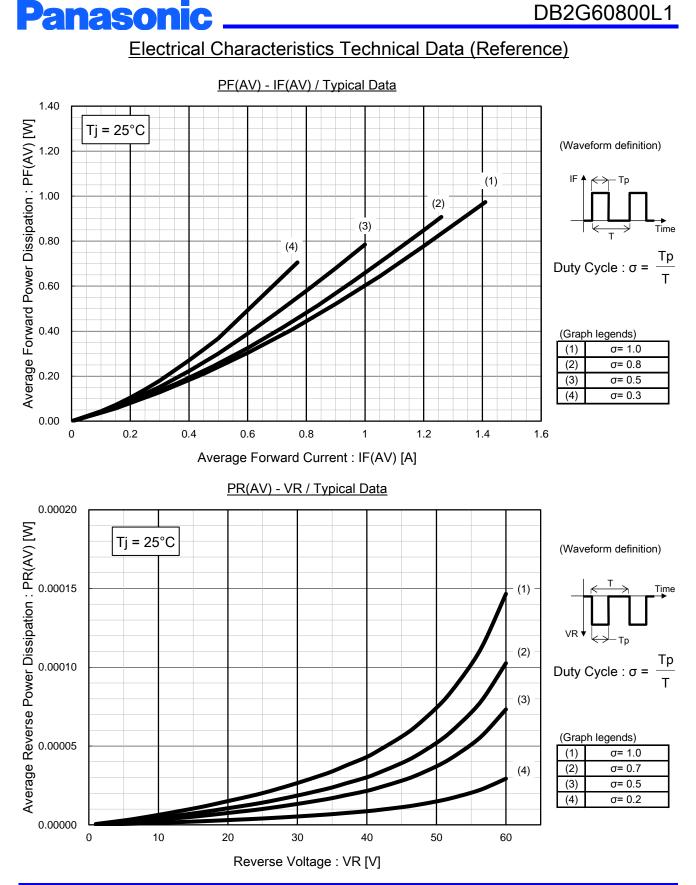


# Electrical Characteristics Technical Data (Reference)

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1.40 Average Forward Power Dissipation : PF(AV) [W] 1.10 1.10 0.80 0.70 0.20 0.30 0.20 0.10 Tj = 150°C (Waveform definition) IF 4 <del><></del>− Tp (1) ⊢**►** Time (2) Duty Cycle :  $\sigma = \frac{Tp}{T}$ (3) (4) (Graph legends) σ= 1.0 (1) σ= 0.8 (2) (3) **σ=** 0.5 (4) σ= 0.3 0.00 0.2 0.4 0 0.6 0.8 1 1.2 1.4 1.6 Average Forward Current : IF(AV) [A] PR(AV) - VR / Typical Data 0.20 Average Reverse Power Dissipation : PR(AV) [W] Tj = 125°C (Waveform definition) 0.15 Time Duty Cycle :  $\sigma = \frac{Tp}{T}$ 0.10 (1) (2) (Graph legends) 0.05 σ= 1.0 (1) (3) σ= 0.7 (2) (3) **σ=** 0.5 (4) (4) **σ=** 0.2 0.00 0 10 20 30 40 50 60 Reverse Voltage : VR [V]

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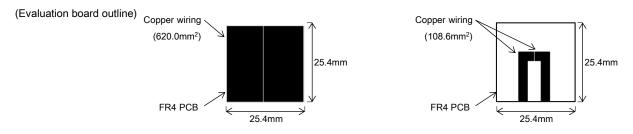


#### Thermal Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Thermal Resistance, Junction to Solder Point	$R_{th(j-sp)}$	Ta = 25°C, in free air	-	20	-	°C/W
Thermal Resistance, Junction to Ambient <sup>*1</sup>	R <sub>th(j-a)</sub>	Ta = 25°C, in free air	-	92	-	°C/W
Thermal Resistance, Junction to Ambient <sup>*2</sup>	R <sub>th(j-a)</sub>	Ta = 25°C, in free air	-	170	-	°C/W

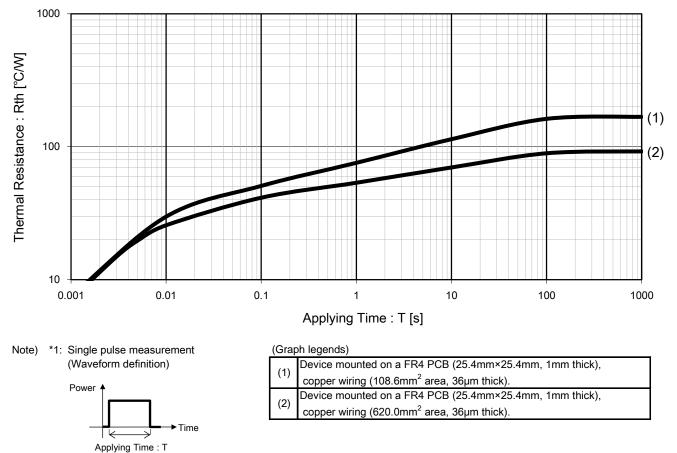
Note) \*1: Device mounted on a FR4 PCB (25.4mm×25.4mm, 1mm thick), copper wiring (620.0mm<sup>2</sup> area, 36µm thick).

\*2: Device mounted on a FR4 PCB (25.4mm×25.4mm, 1mm thick), copper wiring (108.6mm<sup>2</sup> area, 36µm thick).

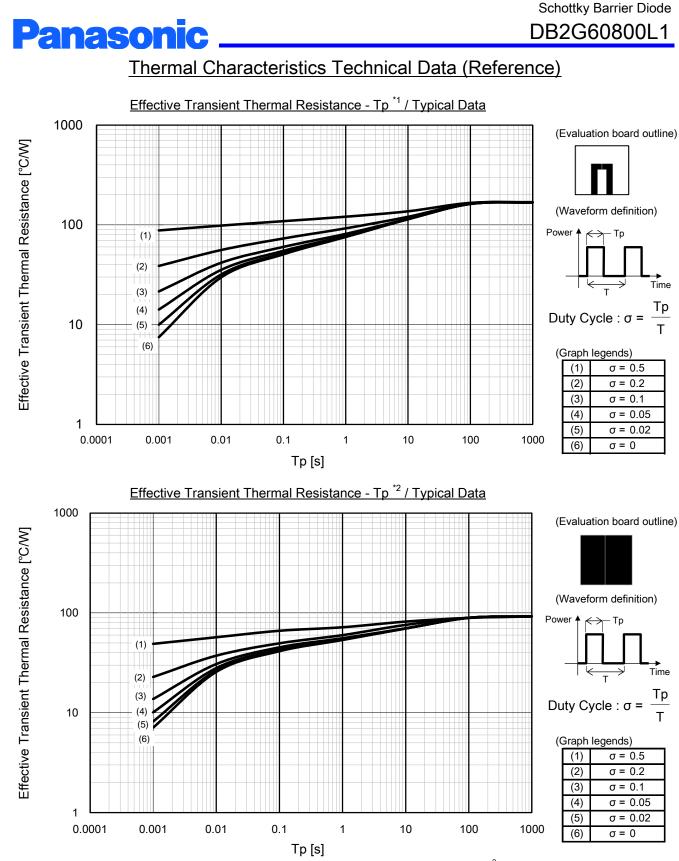


### Thermal Characteristics Technical Data (Reference)

Rth - T \*1 / Typical Data



Doc No. TT4-ZZ-02051 Revision. 0



Note) \*1: Device mounted on a FR4 PCB (25.4mm×25.4mm, 1mm thick), copper wiring (108.6mm<sup>2</sup> area, 36µm thick).
\*2: Device mounted on a FR4 PCB (25.4mm×25.4mm, 1mm thick), copper wiring (620.0mm<sup>2</sup> area, 36µm thick).

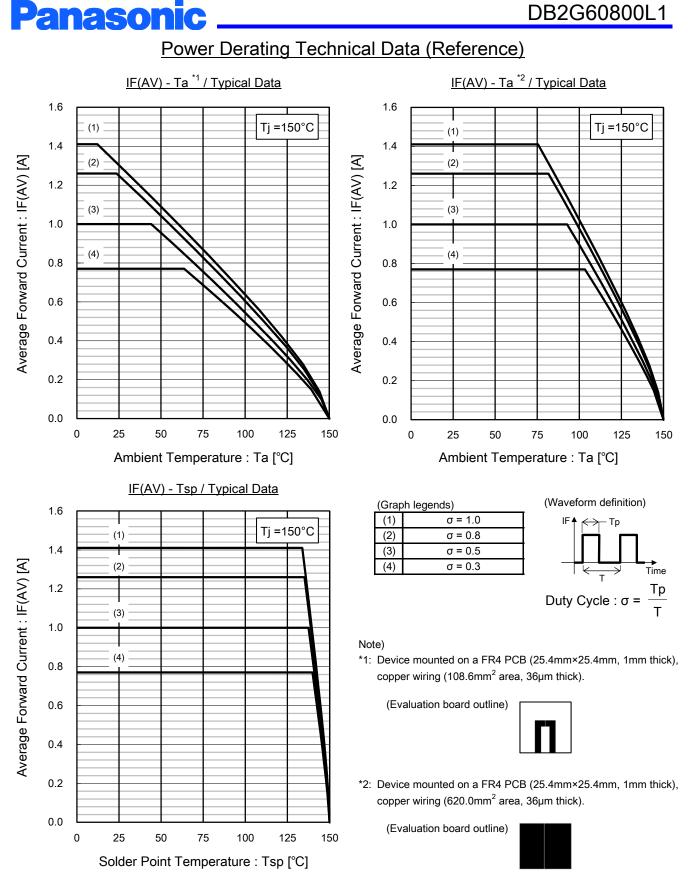
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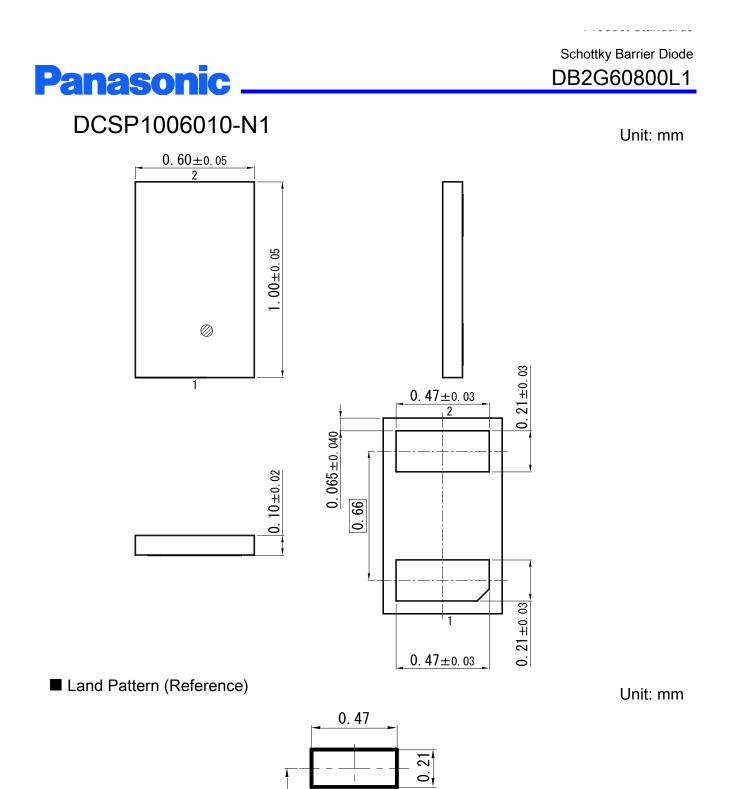
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### Established : 2018-03-08 Revised : ####-##-###



0.21

0.66

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